



HIP6603BECB-T Information



For Reference Only

Part Number HIP6603BECB-T

Manufacturer Intersil

Category Integrated Circuits (ICs)

PMIC - Gate Drivers

DescriptionIC DRIVER MOSF SYNC BUCK 8EPSOICPackage8-SOIC (0.154", 3.90mm Width) Exposed Pad

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



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HIP6603BECB-T Specifications

Manufacturer Part Number HIP6603BECB-T Manufacturer Intersil Category Integrated Circuits (ICs) Package 8-SOIC (0.154", 3.90mm Width) Exposed Pad Series - Driven Configuration Half-Bridge Channel Type Synchronous Number of Drivers 2 Gate Type N-Channel MOSFET Voltage - Supply 10.8 V ~ 13.2 V Logic Voltage - VIL, VIH - Current - Peak Output (Source, Sink) - Input Type Non-Inverting High Side Voltage - Max (Bootstrap) 15 V Rise / Fall Time (Typ) 20ns, 20ns Operating Temperature 0°C ~ 125°C (TJ) Mounting Type Surface Mount Package / Case 8-SOIC (0.154", 3.90mm Width) Exposed Pad Supplier Device Package 8-SOIC-EP		
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Series-Driven ConfigurationHalf-BridgeChannel TypeSynchronousNumber of Drivers2Gate TypeN-Channel MOSFETVoltage - Supply10.8 V ~ 13.2 VLogic Voltage - VIL, VIH-Current - Peak Output (Source, Sink)-Input TypeNon-InvertingHigh Side Voltage - Max (Bootstrap)15VRise / Fall Time (Typ)20ns, 20nsOperating Temperature0°C ~ 125°C (TJ)Mounting TypeSurface MountPackage / Case8-SOIC (0.154", 3.90mm Width) Exposed PadSupplier Device Package8-SOIC-EP		PMIC - Gate Drivers
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Number of Drivers2Gate TypeN-Channel MOSFETVoltage - Supply10.8 V ~ 13.2 VLogic Voltage - VIL, VIH-Current - Peak Output (Source, Sink)-Input TypeNon-InvertingHigh Side Voltage - Max (Bootstrap)15VRise / Fall Time (Typ)20ns, 20nsOperating Temperature0°C ~ 125°C (TJ)Mounting TypeSurface MountPackage / Case8-SOIC (0.154", 3.90mm Width) Exposed PadSupplier Device Package8-SOIC-EP	Driven Configuration	Half-Bridge
Gate TypeN-Channel MOSFETVoltage - Supply10.8 V ~ 13.2 VLogic Voltage - VIL, VIH-Current - Peak Output (Source, Sink)-Input TypeNon-InvertingHigh Side Voltage - Max (Bootstrap)15VRise / Fall Time (Typ)20ns, 20nsOperating Temperature0°C ~ 125°C (TJ)Mounting TypeSurface MountPackage / Case8-SOIC (0.154", 3.90mm Width) Exposed PadSupplier Device Package8-SOIC-EP	Channel Type	Synchronous
Voltage - Supply Logic Voltage - VIL, VIH - Current - Peak Output (Source, Sink) Input Type Non-Inverting High Side Voltage - Max (Bootstrap) Rise / Fall Time (Typ) Operating Temperature O°C ~ 125°C (TJ) Mounting Type Surface Mount Package / Case 8-SOIC (0.154", 3.90mm Width) Exposed Pad Supplier Device Package	Number of Drivers	2
Logic Voltage - VIL, VIH Current - Peak Output (Source, Sink) Input Type Non-Inverting High Side Voltage - Max (Bootstrap) Rise / Fall Time (Typ) Operating Temperature O°C ~ 125°C (TJ) Mounting Type Surface Mount Package / Case 8-SOIC (0.154", 3.90mm Width) Exposed Pad Supplier Device Package	Gate Type	N-Channel MOSFET
Current - Peak Output (Source, Sink) Input Type Non-Inverting High Side Voltage - Max (Bootstrap) Rise / Fall Time (Typ) Operating Temperature O°C ~ 125°C (TJ) Mounting Type Surface Mount Package / Case 8-SOIC (0.154", 3.90mm Width) Exposed Pad Supplier Device Package	Voltage - Supply	10.8 V ~ 13.2 V
Input Type Non-Inverting High Side Voltage - Max (Bootstrap) 15V Rise / Fall Time (Typ) 20ns, 20ns Operating Temperature 0°C ~ 125°C (TJ) Mounting Type Surface Mount Package / Case 8-SOIC (0.154", 3.90mm Width) Exposed Pad Supplier Device Package 8-SOIC-EP	Logic Voltage - VIL, VIH	-
High Side Voltage - Max (Bootstrap) Rise / Fall Time (Typ) Operating Temperature O°C ~ 125°C (TJ) Mounting Type Surface Mount Package / Case 8-SOIC (0.154", 3.90mm Width) Exposed Pad Supplier Device Package	Current - Peak Output (Source, Sink)	-
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Operating Temperature0°C ~ 125°C (TJ)Mounting TypeSurface MountPackage / Case8-SOIC (0.154", 3.90mm Width) Exposed PadSupplier Device Package8-SOIC-EP	High Side Voltage - Max (Bootstrap)	15V
Mounting Type Surface Mount Package / Case 8-SOIC (0.154", 3.90mm Width) Exposed Pad Supplier Device Package 8-SOIC-EP	Rise / Fall Time (Typ)	20ns, 20ns
Package / Case 8-SOIC (0.154", 3.90mm Width) Exposed Pad Supplier Device Package 8-SOIC-EP	Operating Temperature	0°C ~ 125°C (TJ)
Supplier Device Package 8-SOIC-EP	Mounting Type	Surface Mount
	Package / Case	8-SOIC (0.154", 3.90mm Width) Exposed Pad
Report errors?	Supplier Device Package	8-SOIC-EP
*		Report errors

HIP6603BECB-T Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

HIP6603BECB-T Payment Methods



















HIP6603BECB-T Shipping Methods













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